Silicon N-Channel MOS FET

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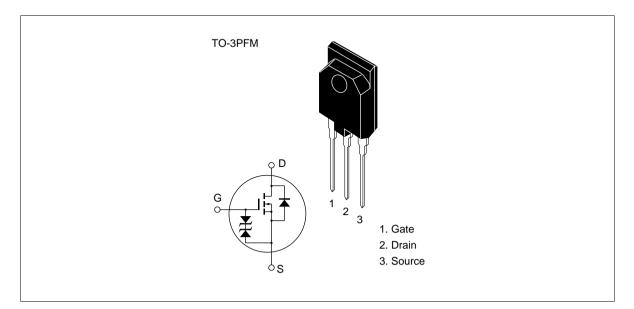
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator and DC-DC converter

Outline





Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Item		Symbol	Ratings	Unit
Drain to source voltage	2SK1328	V _{DSS}	450	V
	2SK1329		500	
Gate to source voltage		V _{GSS}	±30	V
Drain current		I _D	12	A
Drain peak current		L *1 D(pulse)	48	А
Body to drain diode reverse	e drain current	I _{DR}	12	А
Channel dissipation		Pch*2	60	W
Channel temperature		Tch	150	°C
Storage temperature		Tstg	-55 to +150	°C

Notes: 1. $PW \le 10 \ \mu s$, duty cycle $\le 1\%$

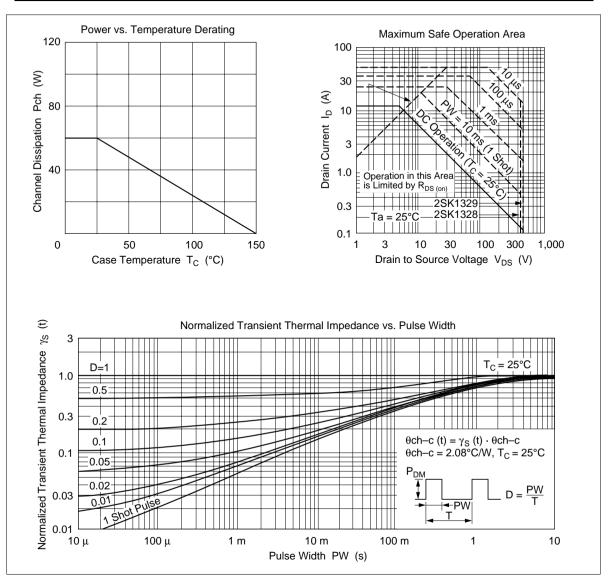
2. Value at $T_c = 25^{\circ}C$

Electrical Characteristics (Ta = 25°C)

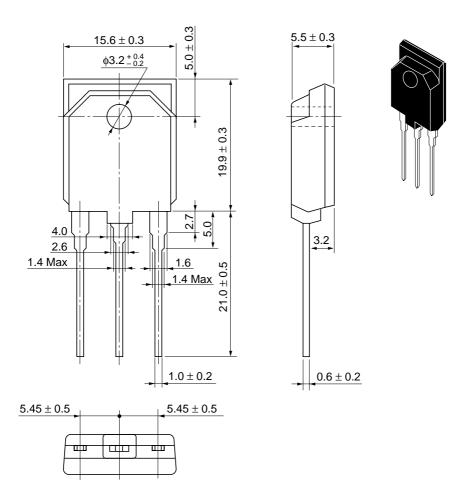
Item		Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source	2SK1328	$V_{(BR)DSS}$	450	_	—	V	$I_{\rm D} = 10$ mA, $V_{\rm GS} = 0$
breakdown voltage	2SK1329	-	500	_			
Gate to source break	down	$V_{(\text{BR})\text{GSS}}$	±30	_	_	V	$I_{g} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current		I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 25$ V, $V_{DS} = 0$
Zero gate voltage	2SK1328	I _{DSS}	_	_	250	μΑ	$V_{\rm DS} = 360$ V, $V_{\rm GS} = 0$
drain current	2SK1329	-					$V_{\rm DS} = 400 \text{ V}, \text{ V}_{\rm GS} = 0$
Gate to source cutoff	voltage	$V_{GS(off)}$	2.0	_	3.0	V	$I_{\rm D} = 1 \text{ mA}, V_{\rm DS} = 10 \text{ V}$
Static Drain to source	2SK1328	$R_{\text{DS(on)}}$	—	0.40	0.55	Ω	$I_{\rm D} = 6 \text{ A}, V_{\rm GS} = 10 \text{ V}^{*1}$
on state resistance	2SK1329	-	_	0.45	0.60	-	
Forward transfer adm	ittance	yfs	6.0	10	_	S	$I_{\rm D} = 6 \text{ A}, V_{\rm DS} = 10 \text{ V}^{*1}$
Input capacitance		Ciss	—	1450	_	pF	$V_{\rm DS} = 10 \ V, \ V_{\rm GS} = 0,$
Output capacitance		Coss	_	410	_	pF	f = 1 MHz
Reverse transfer capacitance		Crss	—	55	_	pF	-
Turn-on delay time		t _{d(on)}	_	20		ns	$I_{\rm D} = 6 \text{ A}, V_{\rm GS} = 10 \text{ V},$
Rise time		t,	_	70	_	ns	$R_{L} = 5 \Omega$
Turn-off delay time		$t_{d(off)}$		120		ns	_
Fall time		t _f		60		ns	
Body to drain diode fo voltage	orward	V_{DF}	_	1.0	_	V	$I_{\rm F} = 12$ A, $V_{\rm GS} = 0$
Body to drain diode re recovery time	everse	t _{rr}	_	450	—	ns	$I_{F} = 12 \text{ A}, V_{GS} = 0,$ $di_{F}/dt = 100 \text{ A}/\mu\text{s}$
Note: 1 Pulse test							- F

Note: 1. Pulse test

See characteristic curves of 2SK1165, 2SK1166.



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Hitachi Code	TO-3PFM			
JEDEC	—			
EIAJ	—			
Weight (reference value)	5.6 g			

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